

## CT40KM-8H

Nch IGBT for Strobe Flasher

REJ03G0286-0200

Rev.2.00

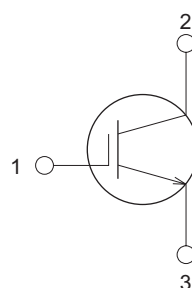
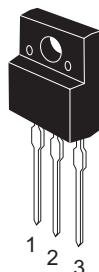
Jul. 07, 2005

### Features

- $V_{CES}$  : 400 V
- TO-220FN package
- High Speed Switching

### Outline

RENESAS Package code: PRSS0003AB-A  
(Package name: TO-220FN)



1 : Gate  
2 : Collector  
3 : Emitter

### Applications

Strobe flashers

### Maximum Ratings

( $T_c = 25^\circ\text{C}$ )

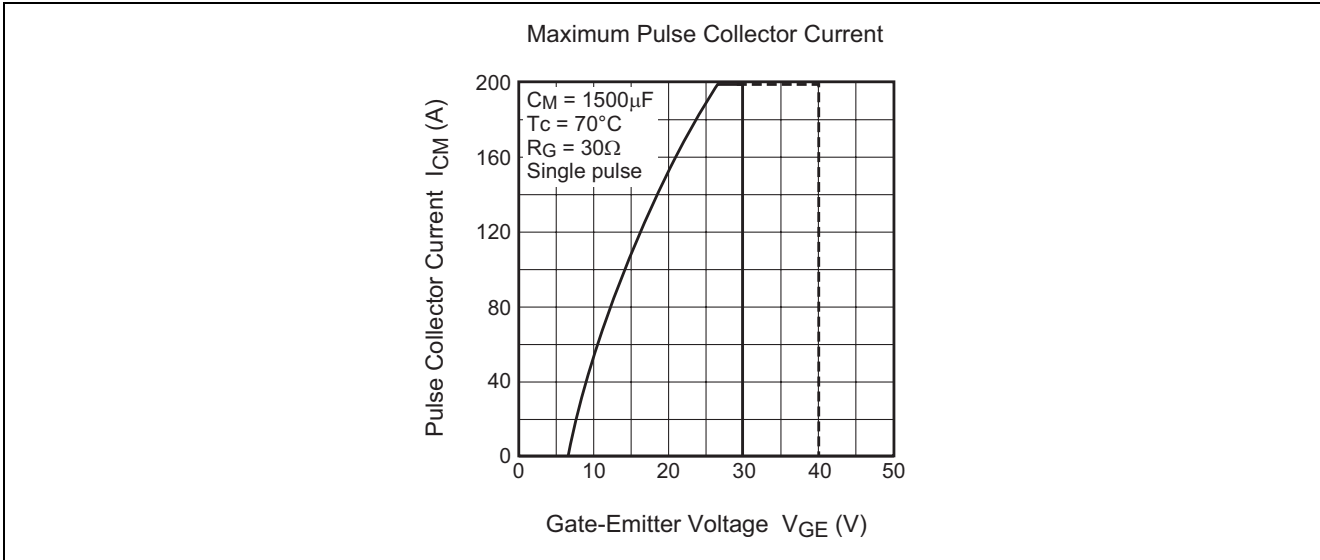
Parameter	Symbol	Ratings	Unit	Conditions
Collector-emitter voltage	$V_{CES}$	400	V	$V_{GE} = 0\text{ V}$
Gate-emitter voltage	$V_{GES}$	30	V	$V_{CE} = 0\text{ V}$ , Refer to item 4 under Notes on the Actual Specifications
Peak gate-emitter voltage	$V_{GEM}$	40	V	$V_{CE} = 0\text{ V}$ , $t_w = 0.5\text{ s}$
Collector current (Pulse)	$I_{CM}$	200	A	$C_M = 1500\text{ }\mu\text{F}$ (see performance curve)
Maximum power dissipation	$P_C$	45	W	
Junction temperature	$T_j$	- 40 to +150	$^\circ\text{C}$	
Storage temperature	$T_{stg}$	- 40 to +150	$^\circ\text{C}$	
Mass	—	2.0	g	Typical value

Electrical Characteristics

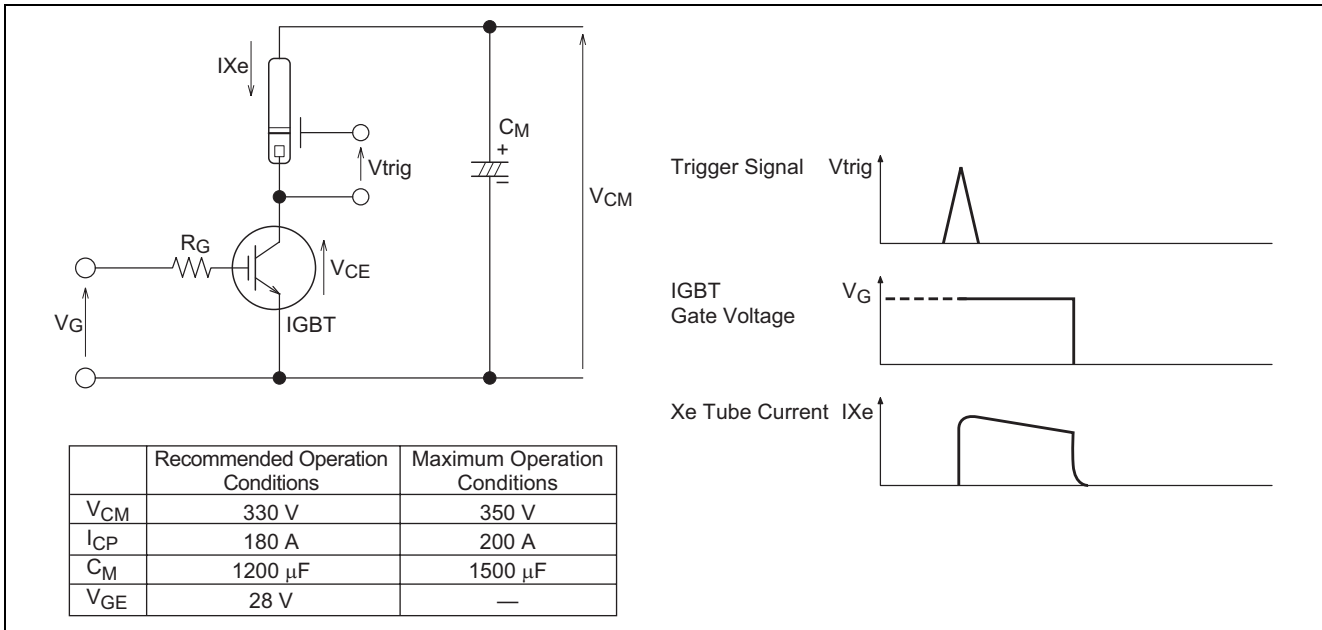
(Tj = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Collector-emitter breakdown voltage	$V_{(BR)CES}$	450	—	—	V	$I_C = 1 \text{ mA}$ , $V_{GE} = 0 \text{ V}$
Collector-emitter leakage current	$I_{CES}$	—	—	10	$\mu\text{A}$	$V_{CE} = 400 \text{ V}$ , $V_{GE} = 0 \text{ V}$
Gate-emitter leakage current	$I_{GES}$	—	—	$\pm 0.1$	$\mu\text{A}$	$V_{GE} = \pm 40 \text{ V}$ , $V_{CE} = 0 \text{ V}$
Gate-emitter threshold voltage	$V_{GE(th)}$	—	—	7.0	V	$V_{CE} = 10 \text{ V}$ , $I_C = 1 \text{ mA}$

Performance Curves



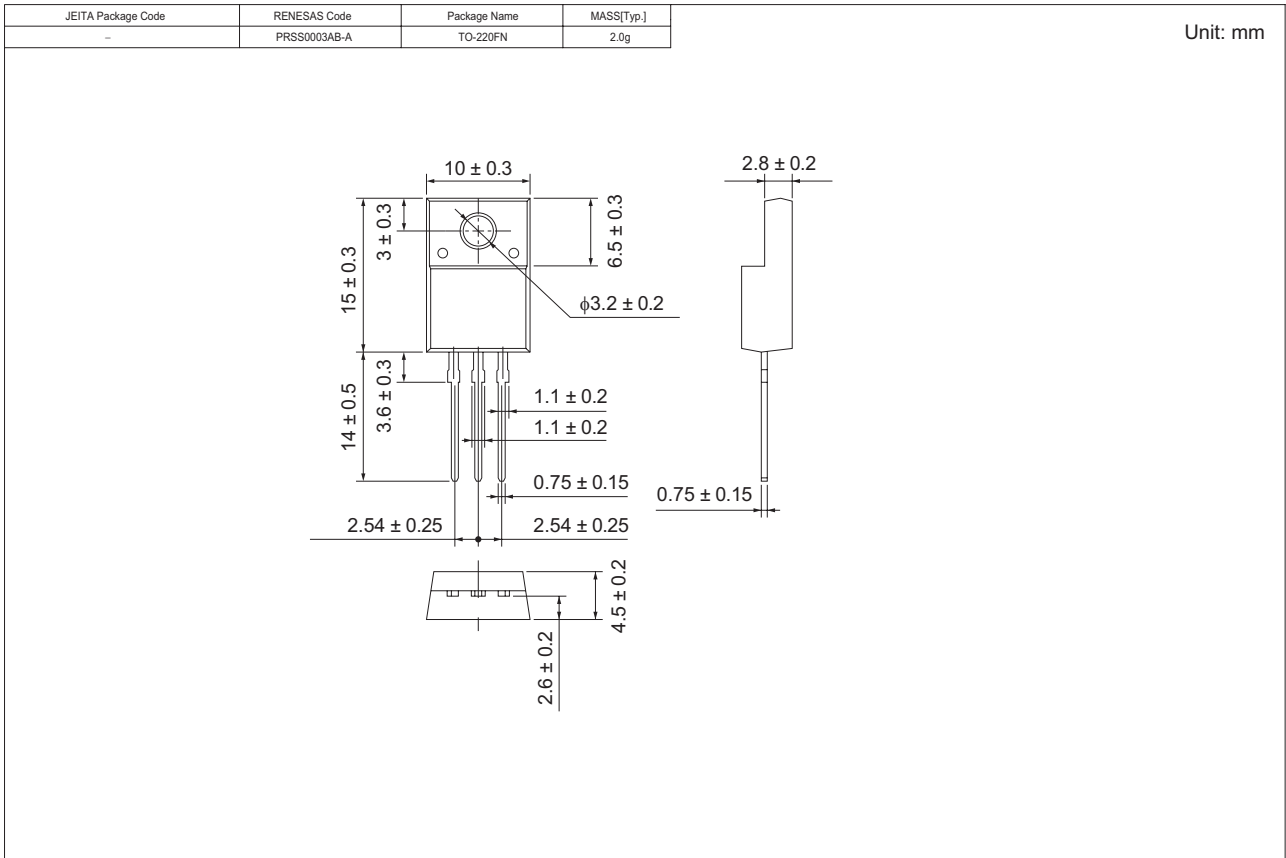
## Application Example



## Precautions on Usage

1. Gate drive voltage during on-period must be applied to satisfy the rating of maximum pulse collector current. And peak reverse gate current during turn-off must become less than 1 A. (In general, when  $R_{G(off)} = 30 \Omega$ , it is satisfied.)
2. IGBT has MOS structure and its gate is insulated by thin silicon oxide. So please handle carefully to protect the device from electrostatic charge.
3. The operation life should be endured 5,000 shots under the charge current ( $I_{Xe} \leq 200$  A : full luminescence condition) of main capacitor ( $C_M = 1500 \mu\text{F}$ ) which can endure repeated discharge of 5,000 times. Repetition period under full luminescence condition is over 3 seconds.
4. Total operation hours applied to the gate-emitter voltage must be within 5,000 hours.

Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Plastic Magazine (Tube)	50	Type name	CT40KM-8H

Note : Please confirm the specification about the shipping in detail.

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#### **Renesas Technology (Shanghai) Co., Ltd.**

Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China  
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

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Tel: <82> 2-796-3115, Fax: <82> 2-796-2145

#### **Renesas Technology Malaysia Sdn. Bhd.**

Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia  
Tel: <603> 7955-9390, Fax: <603> 7955-9510